

In re the Application of:

Docket No.: TI-32531

Scott W. Mitchell et al.

Art Unit:

2829

Serial No.:

10/058,544

Examiner:

Minh Nhut Tang

Filed:

January 25, 2002

Date:

September 23, 2004

Confirmation No.: 3761

MULTIPLE CONTACT VERTICAL PROBE SOLUTION ENABLING

KELVIN CONNECTION BENEFITS FOR CONDUCTIVE BUMP

**PROBING** 

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that on 9-23-04 this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

## AMENDMENT PURSUANT TO 37 C.F.R. § 1.111

Dear Sir:

## **INTRODUCTORY COMMENTS:**

Responsive to the Office Action dated July 14, 2004, the six month statutory period for response having been shortened by three months and now being set to expire on October 14, 2004, please amend the above-identified application as follows: